

DECLARATION FOR NON-PROVISIONAL PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below at 201 et seq. beneath my name.

I believe I am the original, first and sole inventor if only one name is listed at 201 below, or an original, first and joint inventor if plural names are listed at 201 et seq. below, of the subject matter which is claimed and for which a patent is sought on the invention entitled

LOW SPECIFIC GRAVITY THERMOSETTING RESIN COMPOSITION AND METHODS FOR PREPARING SAME

and which patent application bears attorney docket no. 11036-004-999.

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims.

I acknowledge the duty to disclose information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

EARLIEST FOREIGN APPLICATION(S), IF ANY, FILED PRIOR TO THE FILING DATE OF THE APPLICATION			
APPLICATION NUMBER	COUNTRY	DATE OF FILING (day, month, year)	PRIORITY CLAIMED
2001-28431	Korea	23 / 05 /2001	YES <input checked="" type="checkbox"/> NO <input type="checkbox"/>
			YES <input type="checkbox"/> NO <input type="checkbox"/>
			YES <input type="checkbox"/> NO <input type="checkbox"/>

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

2 0 1	FULL NAME OF INVENTOR	LAST NAME CHOI	FIRST NAME CHI-HOON	MIDDLE NAME	
	RESIDENCE & CITIZENSHIP	CITY KYOUNGKI-DO	STATE OR FOREIGN COUNTRY REP. OF KOREA	COUNTRY OF CITIZENSHIP KOREA	
	POST OFFICE ADDRESS	STREET 149-1603 Hwanggoljoogong-Apt., 955-1 Youngtong-dong Paldal-ku, Soowon-si	CITY Kyoungki-do	STATE OR COUNTRY Rep. Of Korea	ZIP
SIGNATURE OF INVENTOR 201 <i>Chi-Hoon Choi</i>			DATE 30/01/2002		

2 0 2	FULL NAME OF INVENTOR	LAST NAME PARK	FIRST NAME SANG-SUN	MIDDLE NAME	
	RESIDENCE & CITIZENSHIP	CITY KYOUNGKI-DO	STATE OR FOREIGN COUNTRY REP. OF KOREA	COUNTRY OF CITIZENSHIP KOREA	
	POST OFFICE ADDRESS	STREET 710-1604 Wooreukjoogong-Apt., 1146-11 Sanbon-dong Kunpo-si	CITY Kyoungki-do	STATE OR COUNTRY Rep. Of Korea	ZIP
SIGNATURE OF INVENTOR 202				DATE <i>Sang Sun Park</i> 30/01/2002	
2 0 3 3 0 6 3 5 2 0 4	FULL NAME OF INVENTOR	LAST NAME AHN	FIRST NAME KYE-WON	MIDDLE NAME	
	RESIDENCE & CITIZENSHIP	CITY SEOUL	STATE OR FOREIGN COUNTRY REP. OF KOREA	COUNTRY OF CITIZENSHIP KOREA	
	POST OFFICE ADDRESS	STREET 1023-805 Mokdongsinsigagi-Apt., 311 Shinjung 1-dong, Yangchun-ku	CITY Seoul	STATE OR COUNTRY Rep. Of Korea	ZIP
SIGNATURE OF INVENTOR 203				DATE <i>Ahn Kye won</i> 30/01/2002	
2 0 3 3 0 6 3 5 2 0 4	FULL NAME OF INVENTOR	LAST NAME RHEE	FIRST NAME JEONG-EEK	MIDDLE NAME	
	RESIDENCE & CITIZENSHIP	CITY KYOUNGKI-DO	STATE OR FOREIGN COUNTRY REP. OF KOREA	COUNTRY OF CITIZENSHIP KOREA	
	POST OFFICE ADDRESS	STREET 406-502 Joogong-Apt., 922-4 Osan-dong, Osan-si	CITY Kyoungki-do	STATE OR COUNTRY Rep. Of Korea	ZIP
SIGNATURE OF INVENTOR 204				DATE <i>Rhee Jeong-Eek</i> 30/01/2002	
2 0 5	FULL NAME OF INVENTOR	LAST NAME	FIRST NAME	MIDDLE NAME	
	RESIDENCE & CITIZENSHIP	CITY	STATE OR FOREIGN COUNTRY	COUNTRY OF CITIZENSHIP	
	POST OFFICE ADDRESS	STREET	CITY	STATE OR COUNTRY	ZIP
SIGNATURE OF INVENTOR 205				DATE	